

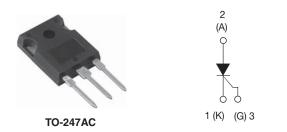
Vishay Semiconductors

RoHS COMPLIANT

HALOGEN

FREE

Thyristor High Voltage, Phase Control SCR, 30 A



PRODUCT SUMMARY	
Package	
B: 1	

Fackage	10-247A0
Diode variation	Single SCR
I _{T(AV)}	20 A
V _{DRM} /V _{RRM}	800 V, 1200 V
V _{TM}	1.3 V
I _{GT}	45 mA
TJ	- 40 °C to 125 °C

TO-2474C

FEATURES

- Designed and qualified according to JEDEC-JESD47
- 125 °C max. operating junction temperature
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

• Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding and battery charge

DESCRIPTION

The VS-30TPS... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I _{T(AV)}	Sinusoidal waveform	20	A						
I _{RMS}		30	A						
V _{RRM} /V _{DRM}		800/1200	V						
I _{TSM}		300	А						
V _T	20 A, T _J = 25 °C	1.3	V						
dV/dt		500	V/µs						
dl/dt		150	A/µs						
TJ		- 40 to 125	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} /V _{DRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA						
VS-30TPS08PbF, VS-30TPS08-M3	800	900	10						
VS-30TPS12PbF, VS-30TPS12-M3	1200	1300	10						



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ABSOLUTE MAXIMUM RATING	S				
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS
Maximum average on-state current	I _{T(AV)}	T _C = 95 °C, 180° conduction	half sine wave	20	
Maximum RMS on-state current	I _{RMS}			30	٨
Maximum peak, one-cycle		10 ms sine pulse, rated V _{RRM} applied		250	A
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no voltage	reapplied	300	
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V_{RRN}	A applied	310	A ² s
Maximum intro rusing	1-1	10 ms sine pulse, no voltage	442	A-5	
Maximum I ² \sqrt{t} for fusing	l²√t	t = 0.1 to 10 ms, no voltage r	4420	A²√s	
Maximum on-state voltage drop	V _{TM}	20 A, T _J = 25 °C	1.3	V	
On-state slope resistance	r _t	T 105 00		12	mΩ
Threshold voltage	V _{T(TO)}	T _J = 125 °C		1.0	V
Maximum reverse and direct leakage current	1/1	T _J = 25 °C	V _R = Rated V _{RRM} /V _{DRM}	0.5	
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	T _J = 125 °C	VR - Haleu VRRM/ VDRM	10	
Maximum holding current	I _H	Anode supply = 6 V, resistive load, initial I_T = 1 A, T_J = 25 $^\circ\text{C}$		150	mA
Maximum latching current	١L	Anode supply = 6 V, resistive load, $T_J = 25 \text{ °C}$			
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, linear to 80 % V_{DRM} , R_g -k = Open			V/µs
Maximum rate of rise of turned-on current	dl/dt			150	A/µs

TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum peak gate power	P _{GM}		8.0	W				
Maximum average gate power	P _{G(AV)}		2.0	vv				
Maximum peak positive gate current	+ I _{GM}		1.5	А				
Maximum peak negative gate voltage	- V _{GM}		10	V				
	I _{GT}	Anode supply = 6 V, resistive load, $T_J = -10 \ ^{\circ}C$	60	-				
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, T_J = 25 °C	45					
		Anode supply = 6 V, resistive load, T_J = 125 °C	20					
		Anode supply = 6 V, resistive load, $T_J = -10 \ ^{\circ}C$	2.5					
Maximum required DC gate voltage to trigger	V _{GT}	Anode supply = 6 V, resistive load, T_J = 25 °C	2.0	v				
volago to algoi		Anode supply = 6 V, resistive load, T_J = 125 °C	1.0	v				
Maximum DC gate voltage not to trigger	V_{GD}	T _{.I} = 125 °C, V _{DBM} = Rated value	0.25					
Maximum DC gate current not to trigger	I _{GD}	$i_{\rm J} = i_{\rm ZO}$ C, $v_{\rm DRM} = nateu value$	2.0	mA				

SWITCHING									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Typical turn-on time	t _{gt}	$T_J = 25 \ ^{\circ}C$	0.9						
Typical reverse recovery time	t _{rr}	T _{.1} = 125 °C	4	μs					
Typical turn-off time	tq	1) = 125 0	110						

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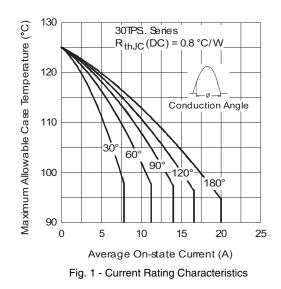
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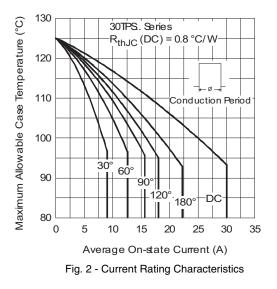


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THERMAL AND MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and sto temperature range	rage	TJ, T _{Stg}		- 40 to 125	°C				
Maximum thermal resistance, junction to case		R _{thJC}	DC operation	0.8					
Maximum thermal resistance, junction to ambient		R _{thJA}		40	°C/W				
Maximum thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.2					
Approvimate weight				6	g				
Approximate weight				0.21	oz.				
minimum				6 (5)	kgf ⋅ cm				
Mounting torque –	maximum			12 (10)	(lbf · in)				
Marking device				30TF	PS08				
			Case style TO-247AC (JEDEC)	30TPS12					







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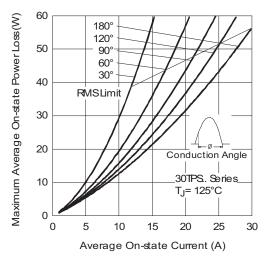


Fig. 3 - On-State Power Loss Characteristics

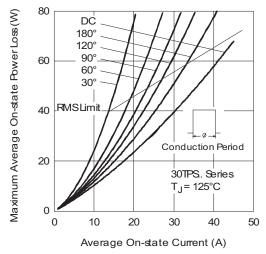


Fig. 4 - On-State Power Loss Characteristics

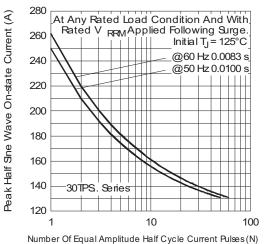


Fig. 5 - Maximum Non-Repetitive Surge Current

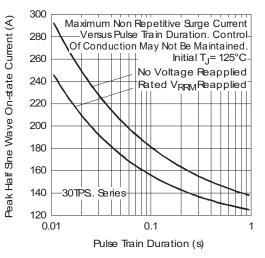
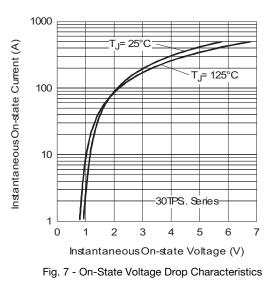


Fig. 6 - Maximum Non-Repetitive Surge Current



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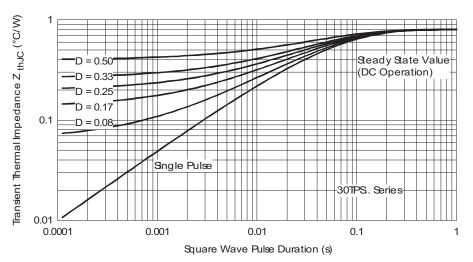
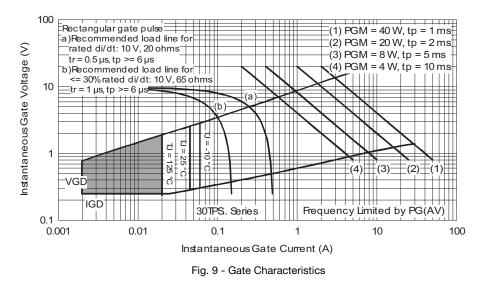


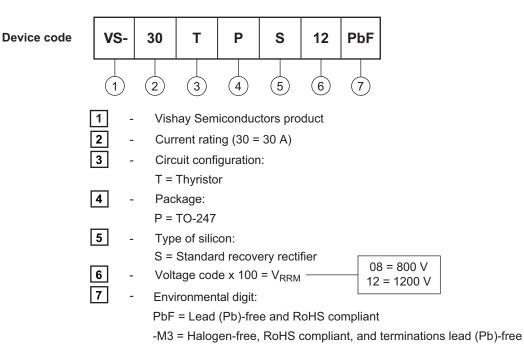
Fig. 8 - Thermal Impedance ZthJC Characteristics





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ORDERING INFORMATION TABLE



ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-30TPS08PbF	25	500	Antistatic plastic tubes						
VS-30TPS08-M3	25	500	Antistatic plastic tubes						
VS-30TPS12PbF	25	500	Antistatic plastic tubes						
VS-30TPS12-M3	25	500	Antistatic plastic tubes						

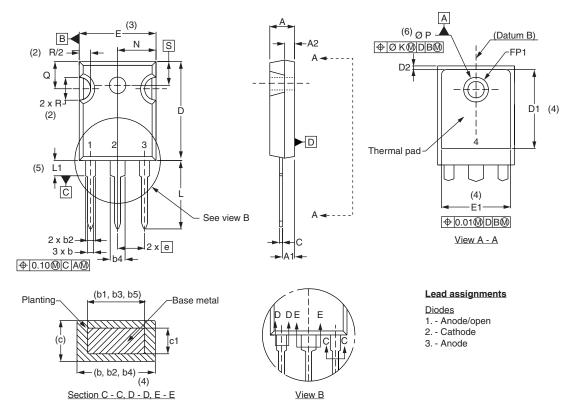
LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?95223						
	TO-247AC PbF	www.vishay.com/doc?95226				
Part marking information	TO-247AC -M3	www.vishay.com/doc?95007				

Outline Dimensions





DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS INCHES		HES	NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STNIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTED	SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209			D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.50	2.49	0.059	0.098			E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			FK	2.	54	0.0)10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.37	0.065	0.094			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ΦP	3.56	3.66	0.14	0.144	
с	0.38	0.86	0.015	0.034			Φ P1	-	6.98	-	0.275	
c1	0.38	0.76	0.015	0.030			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3]	R	4.52	5.49	1.78	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

(6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c

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